

San Diego, CA, USA - July 2018

Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Credit
Abbott, John	Corning Incorporated	Corning Incorporated	1	1	1		3
Abramson, David	Texas Instruments Incorporated	Texas Instruments Incorporated		1	1	1	3
Agnes, Andrea	STMicroelectronics	STMicroelectronics	1	1	1	1	4
Amason, Dale	NXP Semiconductors	NXP Semiconductors	1	1	1	1	4
Anslow, Peter	Ciena Corporation	Ciena Corporation	1	1	1	1	4
BACA, RICHARD	Microsoft Corporation	Microsoft Corporation	1	1	1	1	4
Baggett, Tim	Microchip Technology, Inc.	Microchip Technology, Inc.	1	1	1		3
Bains, Amrik	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Balasubramonian, Venugopal	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.			1		1
Baldwin, Thananya	Keysight Technologies	Keysight Technologies	1	1	1	1	4
Baumgartner, Steven		GLOBALFOUNDRIES	1	1	1	1	4
Beaudoin, Denis	Texas Instruments Incorporated	Texas Instruments Incorporated	1	1	1	1	4
Beauregard, Francois	Belden	Belden			1	1	2
Beruto, Piergiorgio	Canovatech S.r.l.	Canova Tech Srl	1	1		1	3
Bhatt, Vipul	Finisar Corporation	Finisar Corporation		1	1	1	3
bo, gao	Huawei Technologies Co. Ltd	Huawei Technologies Co., Ltd	1	1	1	1	4
Booth, Brad	Microsoft Corporation	Microsoft Corporation	1		1	1	3
Bouda, Martin	Fujitsu Laboratories of America, Inc.	Fujitsu Laboratories of America, Inc.	1	1	1	1	4
Bovington, Jock		Cisco Systems, Inc.	1	1	1	1	4
Boyer, Rich		Aptiv Packard Electric			1	1	2
Brandt, David	Rockwell Automation	Rockwell Automation	1	1		1	3
Braun, Ralf-Peter	Deutsche Telekom AG	Deutsche Telekom AG	1	1	1	1	4
Brillhart, Theodore	Fluke Corporation	Fluke Corporation	1	1	1		3
Brooks, Paul	Viavi solutions GmbH	Viavi Solutions	1	1	1	1	4
Brown, Matthew	MACOM	MACOM	1	1	1		3
Brownlee, Phillip	TDK Corporation	TDK Corporation	1	1	1	1	4
Brychta, Michal	Analog Devices Inc.	Analog Devices Inc.	1	1	1	1	4
Bustos Heredia, Jairo	Wurth Elektronik Group	Wurth Elektronik Group	1	1	1		3
Butter, Adrian	GLOBALFOUNDRIES	GLOBALFOUNDRIES	1	1	1	1	4
Calvin, John	Vital Technical Marketing, Wilder Techno	VTM, V-Prime, Wilder Technologies	1	1	1	1	4
Carlson, Craig	Cavium	Marvell	1	1	1	1	4
Carlson, Steven	High-Speed Design Inc.	Robert Bosch GmbH	1	1	1	1	4

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Carty, Clark	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Cates, Ron	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.		1	1		2
Chabot, Craig	University of New Hampshire InterOper	University of New Hampshire InterOpera	1			1	2
Chalupsky, David	Intel Corporation	Intel Corporation	1	1	1	1	4
Chang, Jacky	Hewlett Packard Enterprise	Hewlett-Packard Development Company	1	1	1	1	4
Chen, Chan	Applied Optoelectronics, Inc.	Applied Optoelectronics, Inc.	1	1	1	1	4
Choudhury, Golam	OFS	OFS	1	1	1	1	4
Chuang, Keng Hua	Hewlett Packard Enterprise	Hewlett-Packard Development Company	1	1	1	1	4
Coenen, Robert	InterOptic	Advantage Optics		1	1	1	3
Cui, zhenwei	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
D'Ambrosia, John	Futurewei Technologies	Futurewei (Subsidiary of Huawei)	1	1	1	1	4
Darshan, Yair	Microsemi Corporation	Microsemi Corporation		1	1		2
Dawe, Piers J G	Mellanox Technologies	Mellanox Technologies	1	1	1	1	4
Dawson, Fred	Chemours Canada Company	Chemours Canada Company	1	1	1	1	4
Deandrea, John	Finisar Corporation	Finisar Corporation	1	1	1		3
den Besten, Gerrit		NXP Semiconductors	1	1	1	1	4
DeSanti, Claudio	Google	Google	1	1	1	1	4
DiBioso, Eric	TE Connectivity	TE Connectivity	1	1	1		3
Diminico, Christopher	M C Communications, LLC	Panduit Corp.	1	1	1		3
Dinh, Thuyen	Pulse Electronics	Pulse Electronics	1		1	1	3
Donahue, Curtis	University of New Hampshire InterOpera	UNH-IOL	1		1	1	3
Du, Liang	Google	Google	1	1	1	1	4
Dube, Kathryn	UNH-IOL	UNH-IOL	1	1		1	3
Dudek, Michael	Cavium	Marvell	1	1	1	1	4
Dupuis, Marc	Web Industries	Web Industries	1	1	1	1	4
Effenberger, Frank	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Estes, David	Spirent Communications	Spirent Communications	1	1	1	1	4
Eyal, Massad	Valens Semiconductor	Valens Semiconductor		1	1	1	3
Fathi Moghadam, Borhan	NVIDIA Corporation	NVIDIA Corporation	1	1	1	1	4
Ferretti, Vincent	Corning Incorporated	Corning Incorporated	1	1	1	1	4
Filip, Jan	Maxim Integrated Products	Maxim Integrated Products			1	1	2
Franchuk, Brian	Emerson Automation Solutions	Emerson Automation Solutions	1	1	1	1	4

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Fritsche, Matthias	HARTING Technologie Gruppe	HARTING Electronics GmbH	1	1	1	1	4
fu, shiyong	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1		3
Gardner, Andrew	Linear Technology	Linear Technology		1	1		2
Gardner, Mike	Molex Incorporated	Molex Incorporated		1	1	1	3
Gauthier, Claude	OmniPhy	NXP Semiconductors	1	1	1	1	4
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC, Huawei LTD		1	1	1	3
Goergen, Joel	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Gong, Zhigang	O-Net Communications Ltd.	O-Net Communications Ltd.	1	1	1	1	4
Gopalakrishnan, Karthik		Inphi Corporation		1	1		2
Gorshe, Steven Scott	Microsemi Corporation	Microsemi Corporation	1	1	1	1	4
Goto, Hideki		Toyota Motor Corporation	1		1	1	3
Graber, Steffen	Pepperl+Fuchs GmbH	Pepperl+Fuchs GmbH	1	1	1	1	4
Grau, Olaf	Robert Bosch GmbH	Robert Bosch GmbH		1	1	1	3
Griffiths, Scott	Rockwell Automation	Rockwell Automation	1	1		1	3
Grow, Robert	RMG Consulting	RMG Consulting	1	1	1	1	4
Gustlin, Mark	Xilinx Inc	Xilinx	1	1	1	1	4
Hajduczenia, Marek	Charter Communications	Charter Communications	1	1	1		3
Han, Ruibo	China Mobile Communications Corporati	China Mobile Communications Corporati		1	1	1	3
Hasharoni, Kobi	DustPhotonics	DustPhotonics	1	1	1		3
Haynes, Hayden	University of New Hampshire InterOpera	University of New Hampshire InterOpera	1	1	1	1	4
Healey, Adam	Broadcom Inc.	Broadcom Inc.	1	1	1	1	4
Heck, Howard	Intel Corporation	Intel Corporation	1	1	1	1	4
Hegde, Rajmohan	Broadcom Corporation	Broadcom Ltd.	1	1		1	3
Hess, David	CORD DATA	CORD DATA	1	1	1	1	4
Holden, Brian	Kandou Bus	Kandou Bus	1	1	1	1	4
Hopkinson, Wayne		CommScope		1	1	1	3
Horner, Rita	Synopsys, Inc.	Synopsys, Inc.	1	1	1	1	4
Hormmeyer, Bernd	Phoenix Contact	Phoenix Contact	1	1	1	1	4
Huszk, Gergely	Self	Kone	1	1		1	3
Ingham, Jonathan	Foxconn Interconnect Technology	Foxconn Interconnect Technology		1	1	1	3
ISHIBE, KAZUHIKO	Anritsu Company	Anritsu Company	1	1	1	1	4
Islinger, Tobias	DENSO AUTOMOTIVE Deutschland	DENSO AUTOMOTIVE Deutschland	1	1	1		3

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Isono, Hideki	FUJITSU	Fujitsu Optical Components Limited	1	1	1	1	4
Issenhuth, Tom	Issenhuth Consulting, LLC	Huawei Technologies Co. Ltd	1	1	1	1	4
Jackson, Kenneth	Sumitomo Electric Device Innovations, U	Sumitomo Electric Industries, LTD	1	1	1	1	4
Jiang, Joy		Google				1	1
Jimenez, Andrew	Anixter Inc.	Anixter Inc.	1	1	1		3
Johnson, John	Broadcom Limited	Broadcom Limited	1	1	1	1	4
Jones, Chad	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Jones, Peter	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1		1	3
JUNG, INYONG		Hyundai Motor Company	1	1	1	1	4
Kabra, Lokesh	Synopsys, Inc.	Synopsys, Inc.	1		1	1	3
Kagami, Manabu	Toyota Central R&D Labs	Toyota Central R&D Labs	1	1	1	1	4
Kanuri, Mrudula		NVIDIA Corporation	1	1	1	1	4
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Kim, Yongbum	NIO	Broadcom Corporation		1	1	1	3
Kimber, Eric	Semtech Ltd	Semtech Ltd	1	1	1	1	4
King, Jonathan	Finisar Corporation	Finisar Corporation		1			1
Kiuchi, Hideki	Japan Aviation Electronics Ind., LTD. (JAE	Japan Aviation Electronics Ind., LTD. (JAE	1	1	1		3
Klaus, Andrew	Marvell Semiconductor, Inc.	JASPAR; Marvell Semiconductor, Inc.	1	1	1	1	4
Knittle, Curtis	Cable Television Laboratories Inc. (Cable	Cable Television Laboratories Inc. (Cable	1	1	1	1	4
Kochuparambil, Elizabeth	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Kolesar, Paul	CommScope	CommScope, Inc.	1	1	1		3
Kondo, Taiji	MegaChips Corporation	MegaChips Corporation	1	1	1	1	4
Kramer, Glen	Broadcom Corporation	Broadcom Corporation	1	1		1	3
Krieger, Olaf	Volkswagen AG	Volkswagen AG			1	1	2
Lackner, Hans	QoSCom GmbH	QoSCom - Quality in Communications - G	1	1	1	1	4
Laubach, Mark	Broadcom Corporation	Broadcom Corporation	1	1	1		3
Law, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	1	1	1	4
Lawlis, James	Ford Motor Company	Ford Motor Company	1	1	1	1	4
Le Cheminant, Greg	Keysight Technologies	Keysight Technologies	1	1		1	3
Lee, June Hee	SAMSUNG ELECTRONICS	SAMSUNG ELECTRONICS	1	1	1	1	4
Leung, Michael	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.		1	1	1	3
Levin, Alex		Microsoft Corporation	1	1	1	1	4

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Lewis, David	Lumentum Inc.	Lumentum Inc.	1	1	1	1	4
Lewis, Jon	Dell EMC	Dell EMC	1	1	1	1	4
Li, David	Ligent Photonics, Inc.	Hisense-Ligent		1	1	1	3
Li, Mike-Peng	Intel Corporation	Intel Corporation		1	1	1	3
Liang, Yongxuan	Applied Optoelectronics INC.	AOI	1	1	1		3
Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.		1	1	1	3
Lin, Alex	MediaTek	MediaTek Inc.	1	1	1	1	4
Lingle, Robert	OFS	OFS	1	1	1	1	4
liu, dekun	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	1		1	3
Liu, Hai-Feng	Intel	Intel Corporation	1	1	1	1	4
Liu, Karen	Lightwave Logic	Lightwave Logic	1	1	1	1	4
Lo, William	Marvell Semiconductor, Inc.	Axonne Inc.	1	1	1	1	4
Lu, Yuchun		HUAWEI	1	1	1	1	4
Lusted, Kent	Intel Corporation	Intel Corporation	1	1	1	1	4
Lyubomirsky, Ilya		Inphi Corporation	1	1	1	1	4
Madgar, Zahy	Valens Semiconductor	Valens Semiconductor		1	1	1	3
Maguire, Valerie	The Siemon Company	The Siemon Company	1	1	1	1	4
Maki, Jeffery	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1	1	4
Malicoat, David	Malicoat Networking Solutions	Aquantia; SENKO Advanced Components	1	1	1	1	4
Marques, Flavio	FURUKAWA ELECTRIC	FURUKAWA ELECTRIC	1	1	1	1	4
Marris, Arthur	Cadence Design Systems, Inc.	Cadence Design Systems, Inc.	1	1	1	1	4
Martin, Arlon		Samtec, Inc.	1	1	1		3
mash, chris	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1	4
MASUDA, TAKEO	OITDA	OITDA	1	1	1		3
Matheus, Kirsten	BMW Group	BMW Group	1	1	1	1	4
Mazzini, Marco	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1		3
Mcclellan, Brett	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1	4
McMillan, Larry	Western Digital Corporation	Western Digital Corporation	1		1	1	3
McSorley, Gregory	Amphenol Corporation	Amphenol Corporation	1		1	1	3
Mein, John	DustPhotonics, INC.	DustPhotonics, LTD	1	1	1		3
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.	1	1	1	1	4
Mercadante, Giacomo	STMicroelectronics	STMicroelectronics	1	1	1		3

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Migueluez, Phil	Comcast	Comcast	1	1	1		3
Miller, Martin	Microchip Technology, Inc.	Microchip Technology, Inc.	1	1	1		3
Moritake, Toshiyuki	Japan Aviation Electronics Ind., LTD. (JAE)	Japan Aviation Electronics Ind., LTD. (JAE)	1	1	1		3
Mueller, Harald	Endress + Hauser	Endress + Hauser	1	1			2
Muller, Shimon	Oracle, Inc.	Axalume, Inc.	1	1	1	1	4
Murty, Ramana	Broadcom Corporation	Broadcom Corporation		1	1		2
Nakamoto, Edward	Spirent Communications	Spirent Communications	1	1	1	1	4
Neveux, Paul	Superior Essex	Superior Essex	1	1	1		3
Nicholl, Gary	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Nishimura, Takeshi	Yamaichi	Yamaichi Electronics				1	1
Nolan, John	QLogic Corporation	QLogic Corporation	1	1	1	1	4
Noll, Kevin	TiBIT Communications	Tibit Communications	1	1	1	1	4
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1		1	3
Ofelt, David	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1	1	4
Ohni, Josef	MD Elektronik GmbH	MD Elektronik	1		1	1	3
Ouellette, Eric		University of New Hampshire InterOpera	1	1	1	1	4
Pachon, Arturo	TE Connectivity	TE Connectivity	1	1	1		3
Palkert, Thomas	EIC	Molex-Macom	1	1	1		3
Pandey, Sujan	NXP Semiconductors	NXP Semiconductors	1	1	1	1	4
PARK, MOON	OE solutions	OE solutions			1		1
Park, Sungkwon	Hanyang Univerisity	Hanyang Univerisity	1				1
Parsons, Earl	CommScope, Inc.	CommScope, Inc.	1	1	1	1	4
Parthasarathy, Vasu	Broadcom Corporation	Broadcom Corporation			1		1
Pepper, Gerald	Keysight Technologies	Keysight Technologies	1	1	1	1	4
Pimpinella, Rick	Panduit Corp.	Panduit Corp.		1	1		2
Poelstra, Henry	Teledyne Lecroy	Teledyne Lecroy	1	1	1		3
Powell, William	Nokia	Nokia	1	1	1	1	4
Pozzebon, Dino	Microsemi Corporation	Microsemi Corporation	1	1	1	1	4
Rabinovich, Rick	Keysight Technologies	Keysight Technologies	1	1	1	1	4
Ran, Adee	Intel Corporation	Intel Corporation	1			1	2
Rashidi, Habib		Pulse Electronics		1	1	1	3
Regev, Alon	Keysight Technologies	Keysight Technologies	1			1	2

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Reinhard, Michael		SEI ANTech-Europe GmbH	1	1	1	1	4
Remein, Duane	Futurewei Technologies	Huawei Technologies Co. Ltd	1	1	1	1	4
Renteria, Victor	Bel Fuse	Bel Fuse	1	1	1	1	4
Sakai, Toshiaki	Socionext	socionext	1	1	1	1	4
Salehi, Hamid	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1		3
Sambasivan, Sam	AT&T	AT&T	1	1	1	1	4
Sayre, Edward	Samtec, Inc.	Teraspeed, a division of Samtec	1	1	1	1	4
Schmitt, Matthew	Cable Television Laboratories Inc. (Cable	Cable Television Laboratories Inc. (Cable			1	1	2
Schuessler, James	SAMSUNG ELECTRONICS	SAMSUNG ELECTRONICS	1	1	1	1	4
Sekel, Steve	Keysight Technologies	Keysight Technologies	1	1	1	1	4
Shirao, Mizuki	Mitsubishi Electric Corporation	Mitsubishi Electric Corporation		1	1		2
Shrikhande, Kapil	Innovium Inc.	Innovium		1	1	1	3
Slavick, Jeff	Broadcom Inc	Broadcom	1	1	1	1	4
Smith, Daniel	Seagate Technology LLC	Seagate Technology LLC	1		1	1	3
Sommers, Scott	Molex Incorporated	Molex Incorporated	1	1	1		3
Souvignier, Tom	Broadcom Corporation	Broadcom Corporation			1		1
Sparrowhawk, Bryan	Leviton Manufacturing Co.	Leviton Manufacturing Co.	1	1	1		3
Sprague, Edward	Infinera Corporation	Infinera Corporation	1	1	1	1	4
Srivastava, Atul	NEL-America	NTT Electronics	1		1		2
Stassar, Peter	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Stewart, Heath	Analog Devices Inc.	Analog Devices Inc.	1	1	1	1	4
Stone, Robert	Broadcom Corporation	Broadcom Corporation		1	1		2
Stover, David	Analog Devices Inc.	Analog Devices Inc.	1		1	1	3
Sun, Junqing	Credo Semiconductor	Credo Semiconductor	1	1		1	3
Sun, Liyang	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1		3
Swanson, Steven	Corning Incorporated	Corning Incorporated		1			1
Tailor, Bharat	Semtech Canada Corporation	Semtech Canada Corporation	1	1	1		3
TAKAHARA, TOMOO	FUJITSU LABORATORIES LIMITED	FUJITSU LABORATORIES LIMITED	1	1	1	1	4
Takefman, Michael	Diablo Technologies	Inphi Corporation	1	1	1	1	4
Tamura, Kohichi	Oclaro Japan Inc.	Oclaro Japan Inc.	1	1	1		3
TAZEBAY, MEHMET	Broadcom Corporation	Broadcom Corporation		1	1	1	3
Tellas, Ronald	Belden	Belden		1	1	1	3

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Thompson, Geoffrey	GraCaSI S.A.	INDEPENDENT	1	1	1	1	4
Tooyserkani, Pirooz	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Tracy, Nathan	TE Connectivity	TE Connectivity	1	1	1		3
Tremblay, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	1	1	1	4
Trowbridge, Stephen	Nokia	Nokia	1	1	1	1	4
TSENG, TA CHIN	Realtek Semiconductor Corp.	Realtek Semiconductor Corp.	1	1	1		3
Tu, Mike	Broadcom Corporation	Broadcom Corporation		1	1	1	3
Twombly, Jeff	Credo Semiconductor	Credo Semiconductor		1	1		2
Ulrichs, Ed	Source Photonics	Source Photonics	1	1	1	1	4
Umnov, Alexander	Corning Incorporated	Corning Incorporated	1	1	1	1	4
Vernickel, Ricky	LEONI	LEONI	1		1	1	3
Villarruel, Fernando	Cisco Systems, Inc.	Cisco Systems, Inc.	1		1		2
Vitali, Marco	Sicoya	Sicoya	1	1			2
Voss, Robert	Panduit Corp.	Panduit Corp.	1	1	1	1	4
wang, haifei	Huawei Technologies Co. Ltd	Huawei Technologies Co., Ltd		1	1	1	3
Wang, Xinyuan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Welch, Brian	Luxtera	Luxtera	1	1	1		3
Wendt, Matthias	Signify (Philips Lighting)	Signify	1			1	2
Wienckowski, Natalie	General Motors Company	General Motors Company	1	1	1	1	4
Withey, James	Fluke Corporation	Fluke Corporation	1	1	1	1	4
Wu, Peter	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1	4
Wucher, Markus	Endress + Hauser Flowtec AG	Endress + Hauser		1			1
Xu, Dayin	Rockwell Automation	Rockwell Automation	1	1		1	3
XU, LI	Huawei Technologies Co. Ltd	HUAWEI	1	1	1	1	4
Xu, Yu	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Yamamoto, Shuto	Nippon Telegraph and Telephone Corpor	Nippon Telegraph and Telephone Corpor	1	1	1	1	4
Yang, Mengna	Applied Optoelectronics, Inc.	Applied Optoelectronics, Inc.	1	1			2
Yasueda, Jim	Teledyne Lecroy	Teledyne Lecroy		1	1		2
YASUKAWA, MASAKI	NEC Magnus Communications, Ltd.	NEC Magnus Communications, Ltd.		1	1	1	3
Young, Adrian	Leviton Manufacturing Co.	Leviton Manufacturing Co.	1	1	1	1	4
Young, James	CommScope, Inc.	CommScope	1	1	1	1	4
Yseboodt, Lennart	Signify	Signify	1	1	1	1	4

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Zambell, Andrew	Amphenol Corporation	Amphenol-FCI	1	1	1	1	4
Zeydel, Bart	MACOM	MACOM	1	1			2
Zhou, Richard (Yujia)	Charter Communications	Charter Communications	1		1	1	3
Zhuang, Yan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Zimmerman, George	CME Consulting	ADI, APL Group, Aquantia, BMW, CommS	1	1	1		3
Zivny, Pavel	Tektronix, Inc.	Tektronix, Inc.	1	1	1	1	4
Zweck, Harald	Infineon Technologies AG	Infineon Technologies AG	1	1	1	1	4